# **Dual 2-Input NOR Gate**

The NL27WZ02 is a high performance dual 2-input NOR Gate operating from a 1.65 V to 5.5 V supply.

#### **Features**

- Extremely High Speed:  $t_{PD}$  2.5 ns (typical) at  $V_{CC} = 5.0 \text{ V}$
- Designed for 1.65 V to 5.5 V V<sub>CC</sub> Operation
- Over Voltage Tolerant Inputs
- $\bullet~$  LVTTL Compatible Interface Capability With 5.0 V TTL Logic with  $V_{CC}=3.0~\text{V}$
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current Substantially Reduces System Power Requirements
- Replacement for NC7WZ02
- Chip Complexity: FET = 112
- Pb-Free Package is Available

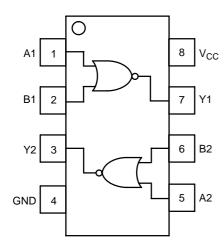


Figure 1. Pinout



Figure 2. Logic Symbol



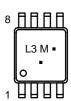
### ON Semiconductor®

http://onsemi.com

### MARKING DIAGRAM



US8 US SUFFIX CASE 493



L3 = Specific Device Code

M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)
\*Date Code orientation may vary depending upon manufacturing location.

#### **PIN ASSIGNMENT**

Pin	Function		
1	A1		
2	B1		
3	Y2		
4	GND		
5	A2		
6	B2		
7	Y1		
8	V <sub>CC</sub>		

#### **FUNCTION TABLE**

Inp	Output $Y = \overline{A + B}$	
Α	В	Y
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

#### **MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit	
DC Supply Voltage		V <sub>CC</sub>	-0.5  to  +7.0	V
DC Input Voltage		VI	-0.5  to  +7.0	V
DC Output Voltage		Vo	-0.5  to  +7.0	V
DC Input Diode Current	V <sub>I</sub> < GND	I <sub>IK</sub>	-50	mA
DC Output Diode Current	V <sub>O</sub> < GND	I <sub>OK</sub>	-50	mA
DC Output Sink Current		Io	±50	mA
DC Supply Current per Supply Pin		I <sub>CC</sub>	±100	mA
DC Ground Current per Ground Pin		I <sub>GND</sub>	±100	mA
Storage Temperature Range		T <sub>STG</sub>	-65 to +150	°C
Lead Temperature, 1 mm from Case for 10 Sec	onds	TL	260	°C
Junction Temperature under Bias		TJ	+150	°C
Thermal Resistance (Note 1)		$\theta_{JA}$	250	°C/W
Power Dissipation in Still Air at 85°C		P <sub>D</sub>	250	mW
Moisture Sensitivity		MSL	Level 1	
Flammability Rating	Oxygen Index: 28 to 34	F <sub>R</sub>	UL 94 V-0 @ 0.125 in	
ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	V <sub>ESD</sub>	> 2000 > 200 N/A	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace with no air flow.
- Tested to EIA/JESD22-A114-A.
   Tested to EIA/JESD22-A115-A.
- 4. Tested to JESD22-C101-A.

### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min	Max	Unit	
Supply Voltage	Operating Data Retention Only	V <sub>CC</sub>	1.65 1.5	5.5 5.5	V
Input Voltage (Note 5)		VI	0	5.5	V
Output Voltage	(HIGH or LOW State)	V <sub>O</sub>	0	V <sub>CC</sub>	V
Operating Free-Air Temperature		T <sub>A</sub>	-40	+85	°C
Input Transition Rise or Fall Rate	$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V} \\ V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V} \\ V_{CC} = 3.0 \text{ V} \pm 0.3 \text{ V} \\ V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	Δt/ΔV	0 0 0	20 20 10 5	ns/V

<sup>5.</sup> Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

#### DC ELECTRICAL CHARACTERISTICS

			V <sub>CC</sub>	Т	$T_A = 25^{\circ}C$		-40°C ≤	<b>T</b> <sub>A</sub> ≤ 85°C	
Parameter	Condition	Symbol	(V)	Min	Тур	Max	Min	Max	Unit
High-Level Input Voltage		V <sub>IH</sub>	1.65 2.3 to 5.5	0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>			0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>		V
Low-Level Input Voltage		V <sub>IL</sub>	1.65 2.3 to 5.5			0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>		0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>	V
High-Level Output Voltage V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	$I_{OH} = -100 \mu A$ $I_{OH} = -4 mA$ $I_{OH} = -8 mA$ $I_{OH} = -12 mA$ $I_{OH} = -16 mA$ $I_{OH} = -24 mA$ $I_{OH} = -32 mA$	V <sub>ОН</sub>	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	V <sub>CC</sub> - 0.1 1.29 1.9 2.2 2.4 2.3 3.8	V <sub>CC</sub> 1.5 2.1 2.4 2.7 2.5 4.0		V <sub>CC</sub> - 0.1 1.29 1.90 2.20 2.40 2.30 3.80		V
Low-Level Output Voltage V <sub>IN</sub> = V <sub>IH</sub> or V <sub>OH</sub>	I <sub>OL</sub> = 100 µA I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 8 mA I <sub>OL</sub> = 12 mA I <sub>OL</sub> = 16 mA I <sub>OL</sub> = 24 mA I <sub>OL</sub> = 32 mA	V <sub>OL</sub>	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5		0.0 0.08 0.20 0.22 0.28 0.38 0.42	0.1 0.24 0.3 0.4 0.4 0.55 0.55		0.1 0.24 0.3 0.4 0.4 0.55 0.55	V
Input Leakage Current	$V_{IN} = V_{CC}$ or GND	I <sub>IN</sub>	0 to 5.5			±0.1		±1.0	μΑ
Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	Icc	5.5			1.0		10	μΑ

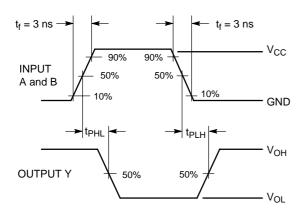
### AC ELECTRICAL CHARACTERISTICS $t_R = t_F = 3.0 \text{ ns}$

			V <sub>CC</sub>	$T_A = 25^{\circ}C$		;	-40°C ≤ 7	$\Gamma_{A} \leq 85^{\circ}C$	
Parameter	Condition	Symbol	(V)	Min	Тур	Max	Min	Max	Unit
Propagation Delay	$R_L = 1 M\Omega$ , $C_L = 15 pF$	t <sub>PLH</sub>	1.8 ± 0.15	2.0	7.4	9.5	2.0	9.7	ns
(Figure 3 and 4)		t <sub>PHL</sub>	2.5 ± 0.20	1.2	3.3	5.4	1.2	5.8	
	$\begin{aligned} R_L &= 1 \text{ M}\Omega, C_L = 15 \text{ pF} \\ R_L &= 500 \ \Omega, C_L = 50 \text{ pF} \end{aligned}$		$3.3 \pm 0.30$	0.8 1.2	2.6 3.2	3.9 4.8	0.8 1.2	4.3 5.2	
	$\begin{aligned} R_L &= 1 \text{ M}\Omega, C_L = 15 \text{ pF} \\ R_L &= 500 \ \Omega, C_L = 50 \text{ pF} \end{aligned}$		5.0 ± 0.50	0.5 0.8	1.9 2.5	3.1 3.7	0.5 0.8	3.3 4.0	

### **CAPACITIVE CHARACTERISTICS**

Parameter	Condition	Symbol	Typical	Unit
Input Capacitance	$V_{CC} = 5.5 \text{ V}, V_I = 0 \text{ V or } V_{CC}$	C <sub>IN</sub>	2.5	pF
Power Dissipation Capacitance (Note 6)	10 MHz, $V_{CC} = 3.3 \text{ V}$ , $V_I = 0 \text{ V}$ or $V_{CC}$ 10 MHz, $V_{CC} = 5.5 \text{ V}$ , $V_I = 0 \text{ V}$ or $V_{CC}$	C <sub>PD</sub>	9.0 11.0	pF

<sup>6.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no–load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.



INPUT OUTPUT  $= \begin{cases} R_L & = C_L \end{cases}$ 

A 1–MHz square input wave is recommended for propagation delay tests.

Figure 3. Switching Waveform

Figure 4. Test Circuit

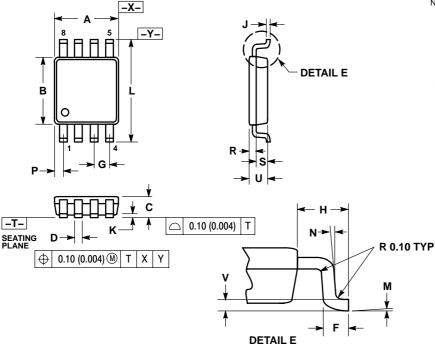
### **ORDERING INFORMATION**

			Device No	menclature				
Device	Logic Circuit Indicator	No. of Gates per Package	Temp Range Identifier	Technology	Device Function	Package Suffix	Package	Shipping <sup>†</sup>
NL27WZ02US	NL	2	7	WZ	02	US	US8	3000/Tape & Reel
NL27WZ02USG	INL	2	,	VVZ	02	03	036	3000/Tape & Neel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

### US8 CASE 493-02 **ISSUE B**



#### NOTES

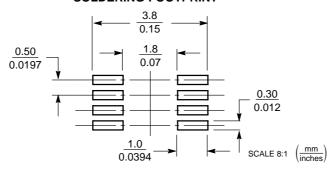
- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSION "A" DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURR. MOLD FLASH. PROTRUSION AND GATE BURR SHALL NOT EXCEED 0.140 MM (0.0055") PER SIDE.
  DIMENSION "B" DOES NOT INCLUDE
- INTER-LEAD FLASH OR PROTRUSION. INTER-LEAD FLASH AND PROTRUSION SHALL NOT E3XCEED 0.140 (0.0055") PER SIDE
- LEAD FINISH IS SOLDER PLATING WITH THICKNESS OF 0.0076–0.0203 MM. (300–800 ").
  ALL TOLERANCE UNLESS OTHERWISE
- SPECIFIED ±0.0508 (0.0002 ").

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.90	2.10	0.075	0.083
В	2.20	2.40	0.087	0.094
С	0.60	0.90	0.024	0.035
D	0.17	0.25	0.007	0.010
F	0.20	0.35	0.008	0.014
G	0.50	BSC	0.020	BSC
Н	0.40	REF	0.016	REF
J	0.10	0.18	0.004	0.007
K	0.00	0.10	0.000	0.004
L	3.00	3.20	0.118	0.126
М	0 °	6°	0 °	6 °
N	5 °	10 °	5 °	10 °
Р	0.23	0.34	0.010	0.013
R	0.23	0.33	0.009	0.013
S	0.37	0.47	0.015	0.019
C	0.60	0.80	0.024	0.031
٧	0.12	BSC	0.005	BSC

### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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